Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information						
Supplier	· Information															
Company	name*	Company unique ID			1	Unique ID Authority					Response Date*					
onsemi													2025-08-23			
Contact N	ame	Title - Contact			1	Phone - Contact*					Email - Contact*					
Product-E	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Authorize	d Representative*	Title - Representative]	Phone - Representative*				Email - Representative*						
Product-E	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Date	Fective Date Version Manufacturing Site		ng Site	Wei	ight*	UOM	Unit Type		
		NVH4L0	NVH4L080N120SC1 SiC MO		MOS TO247-4L 80mohm 1200V		2025-08-23		•	СРА		637	8.37	mg	Each	
Manufac	cturing Proccess Informat	ion						,								
	Terminal Plating / Grid Array Material T		Cerminal Base Alloy J-ST		J-STD-020 MSL	Rating	Peak Prod	Process Body Temperature Max Time		ne at Peak	Peak Temperature Nur		er of Reflow Cyc	eles		
	Matte Tin (Sn) - annealed		CU Alloy NA		NA		0		С	30		seconds	3			
Comments																
or more i	information regarding material (composition	please refer to	page 3		_										

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-En									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.29	mg	Supplier	Silicon Carbide	409-21-2		5.29	mg
Die Attach Solder	7.49	mg	Supplier	Silver (Ag)	7440-22-4		0.1873	mg
			A	Lead (Pb)	7439-92-1	7a	6.9282	mg
			Supplier	Tin (Sn)	7440-31-5		0.3745	mg
Lead Frame	3982.39		В	Nickel (Ni)	7440-02-0		9.5577	mg
			Supplier	Iron (Fe)	7439-89-6		5.9736	mg
			Supplier	Copper (Cu)	7440-50-8		3965.2656	mg
			Supplier	Phosphorus (P)	7723-14-0		1.593	mg
Mold Compound-Black	2349.04			Epoxy resin	proprietary data		70.4712	mg
			Supplier	Phenolic Resin	Proprietary Data		35.2356	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		352.356	mg
			Supplier	Carbon Black (C)	1333-86-4		11.7452	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1879.2321	mg
Plating	23.4	mg	Supplier	Tin (Sn)	7440-31-5		23.4	mg
Wire Bond - Al	10.76	mg	Supplier	Aluminum (Al)	7429-90-5		10.76	mg